

HOSTAFORM®

Chemical abbreviation according to ISO 1043-1: POM Molding compound ISO 29988- POM-K, M-GNR, 04-002 POM copolymer Easy flowing Injection molding type like C 13021, but with higher strength, rigidity and hardness over the entire permissible temperature range for HOSTAFORM; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation. Monomers and additives are listed in EU-Regulation (EU) 10/2011 FDA compliant according to 21 CFR 177.2470 UL-registration for all colours and a thickness more than 1.5 mm as UL 94 HB; burning rate ISO 3795 and FMVSS 302 < 75 mm/min for a thickness more than 1 mm. Ranges of applications: For molded parts with higher requirements to strength, rigidity und hardness, ranges of applications with fuel contact. FDA = Food and Drug Administration (USA) UL = Underwriters Laboratories (USA) FMVSS = Federal Motor Vehicle Safety Standard (USA).

ECO-B: Hostaform ECO-B is a POM-Copolymer with the same properties and performance as standard grades but produced with sustainability in mind. Using a mass-balance approach, biogenic feedstocks are used to offset the use of fossil-based raw materials and decrease greenhouse gas emissions. The process is audited and certified according to the ISCC Plus mass balance approach.

Product information

Resin Identification Part Marking Code	POM >POM<		ISO 1043 ISO 11469
Rheological properties			
Melt volume-flow rate	12	cm ³ /10min	ISO 1133
Temperature	190		
Load	2.16	kg	
Moulding shrinkage, parallel	2.0	-	ISO 294-4, 2577
Moulding shrinkage, normal	1.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	3050	MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	68	MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	8	%	ISO 527-1/-2
Nominal strain at break	28	%	ISO 527-1/-2
Flexural modulus	3000	MPa	ISO 178
Compressive stress at 1% strain	31	MPa	ISO 604
Tensile creep modulus, 1h	2750	MPa	ISO 899-1
Tensile creep modulus, 1000h	1450		ISO 899-1
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Ball indentation hardness, H 358/30		MPa	ISO 2039-1
Poisson's ratio	0.428		
Thermal properties			
Melting temperature, 10°C/min	170	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	107	°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	161	°C	ISO 75-1/-2
Coefficient of linear thermal expansion	110	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Thermal conductivity of melt	0.155	W/(m K)	ISO 22007-2

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HOSTAFORM® C 13031 ECO-B

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Flammability				
Burning Behav. at 1.5mm nom. thickr	l.		class	IEC 60695-11-10
Thickness tested			mm	IEC 60695-11-10
Burning Behav. at thickness h Thickness tested			class mm	IEC 60695-11-10 IEC 60695-11-10
UL recognition		yes	111111	UL 94
		yee		0201
Electrical properties				
Relative permittivity, 100Hz		4		IEC 62631-2-1
Relative permittivity, 1MHz		4		IEC 62631-2-1
Dissipation factor, 100Hz		-	E-4	IEC 62631-2-1
Dissipation factor, 1MHz			E-4	IEC 62631-2-1
Volume resistivity			Ohm.m	IEC 62631-3-1
Surface resistivity		1E14		IEC 62631-3-2
Electric strength		600	kV/mm	IEC 60243-1 IEC 60112
Comparative tracking index		600		IEC 00112
Physical/Other properties				
Humidity absorption, 2mm		0.2	%	Sim. to ISO 62
Water absorption, 2mm		0.65	%	Sim. to ISO 62
Density		1410	kg/m³	ISO 1183
Injection				
Drying Recommended		no		
Drying Temperature		100	°C	
Drying Time, Dehumidified Dryer		3 - 4	h	
Processing Moisture Content		≤0.2	%	
Melt Temperature Optimum		200	°C	
Min. melt temperature		190	°C	
Max. melt temperature		210	°C	
Screw tangential speed		≤0.3		
Mold Temperature Optimum		100		
Min. mould temperature			°C	
Max. mould temperature		120	-	
Hold pressure range		60 - 120		
Back pressure		4	MPa	
Characteristics				
Processing	Injection Moulding			
Delivery form	Pellets			

Additives

Sustainability

Release agent

Bio-Content





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Additional information

Injection molding

Preprocessing

General drying is not necessary due to low moisture absorption of the resin.

In case of bad storage conditions (water contact or condensed water) the use of a recirculating air dryer (100 to 120 °C / max. 40 mm layer / 3 to 6 hours) is recommended.

Max. Water content 0,2 %

Processing

Standard injection moulding machines with three phase (15 to 25 D) plasticating screws will fit.

Postprocessing

Conditioning e.g. moisturizing is not necessary.

Processing Notes

Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.

Storage

The product can then be stored in standard conditions until processed.

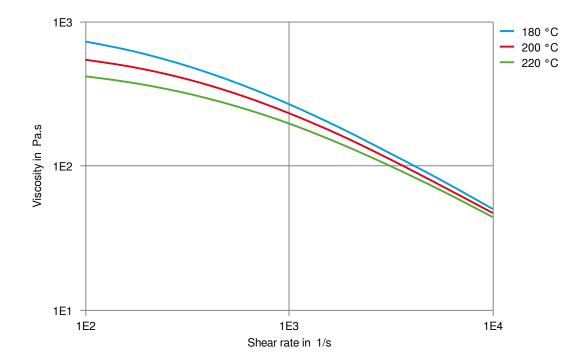
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Viscosity-shear rate

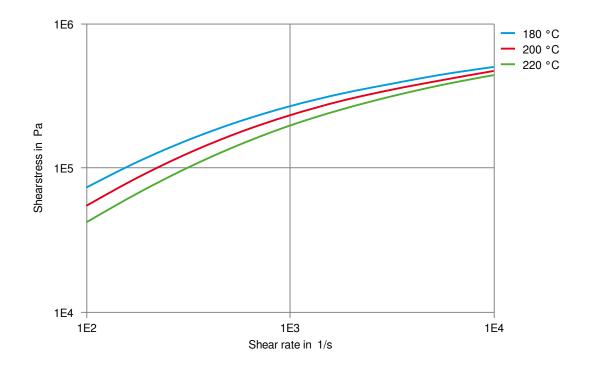






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Shearstress-shear rate

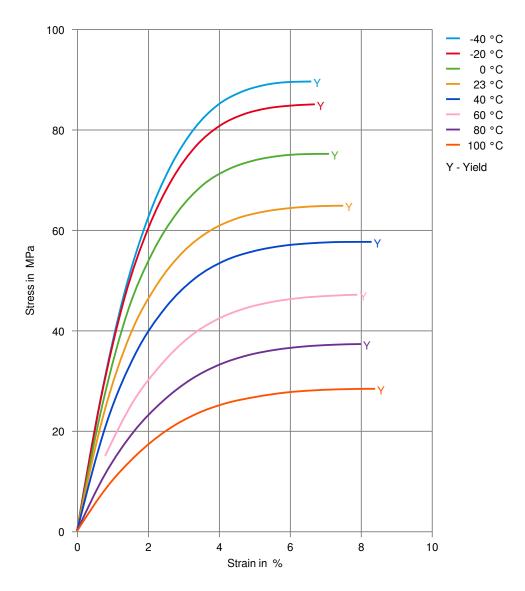






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Stress-strain



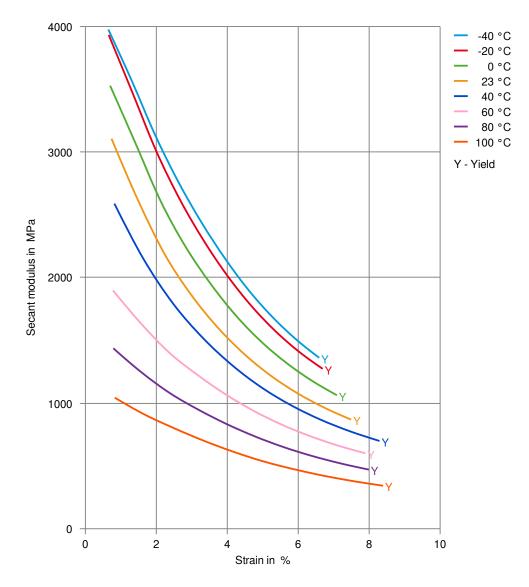




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Secant modulus-strain

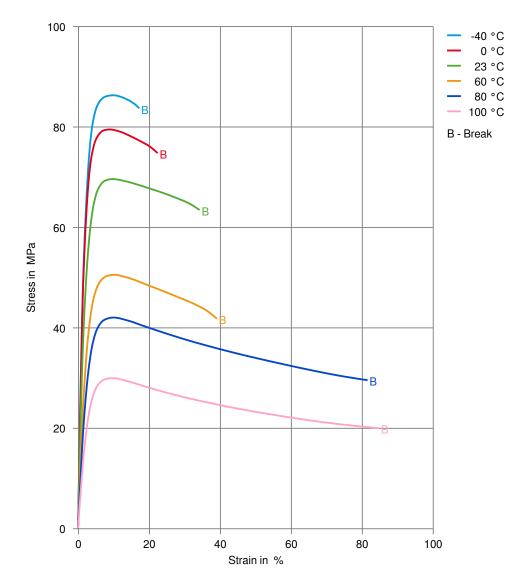






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Stress-strain, 50mm/min

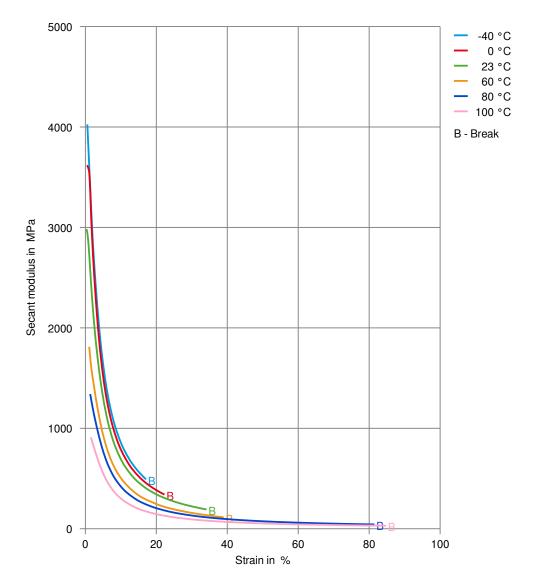






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Secant modulus-strain, 50mm/min

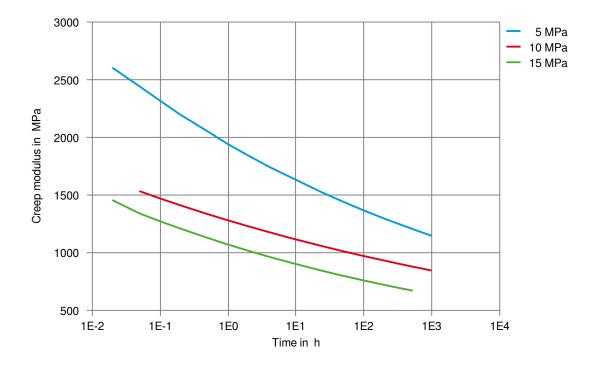






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Creep modulus-time 80°C

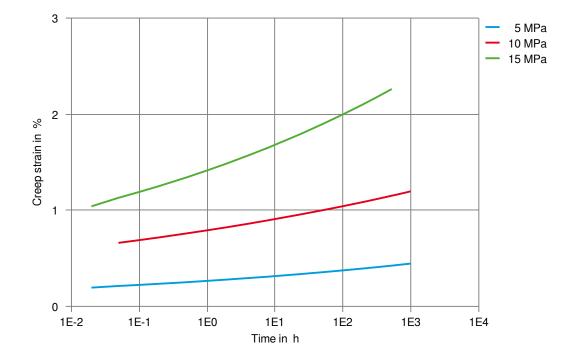






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Creep strain-time 80°C



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